

# 1NM65-Q

## **Power MOSFET**

# 1.0A, 650V N-CHANNEL SUPER-JUNCTION MOSFET

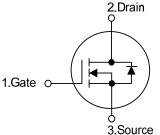
#### DESCRIPTION

The UTC 1NM65-Q is a Super Junction MOSFET Structure and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and a high rugged avalanche characteristics. This power MOSFET is usually used at DC-DC, AC-DC converters for power applications.

#### **FEATURES**

- \*  $R_{DS(ON)}$  < 4.6 $\Omega$  @  $V_{GS}$  = 10V,  $I_D$  =0.5A
- \* Fast switching capability
- \* Avalanche energy specified
- \* Improved dv/dt capability, high ruggedness

#### SYMBOL



2.Drain

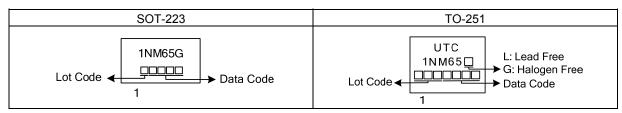
# SOT-223 TO-251

ORDERING INFORMATION
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Ordering	Daakaga	Pin Assignment			Deaking		
Lead Free	Halogen Free	Package	1	2	3	Packing	
-	1NM65G-AA3-R	SOT-223	G	D	S	Tape Reel	
1NM65L-TM3-T	1NM65G-TM3-T	TO-251	G	D	S	Tube	
Note: Pin Assignment: G: G							

1NM65 <u>G-TA3</u> -R (1)Packing Type	(1) T: Tubel, R: Tape Reel
(2)Package Type	(2) AA3: SOT-223, TM3: TO-251
(3)Green Package	(3) L: Lead Free, G: Halogen Free and Lead Free

#### MARKING



## ■ **ABSOLUTE MAXIMUM RATINGS** (T<sub>c</sub> = 25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V <sub>DSS</sub>	650	V
Gate-Source Voltage		V <sub>GSS</sub>	±30	V
Drain Current	Continuous	I <sub>D</sub>	1.0	А
	Pulsed (Note 2)	I <sub>DM</sub>	4.0	А
Avalanche Current (Note 2)		I <sub>AR</sub>	1.3	А
Avalanche Energy Single Pulsed (Note 3)		E <sub>AS</sub>	8.5	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	4.6	V/ns
Power Dissipation	SOT-223	PD	10	W
	TO-251		28	W
Junction Temperature		TJ	+150	°C
Storage Temperature		T <sub>STG</sub>	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating: Pulse width limited by maximum junction temperature.

3. L=10mH, I<sub>AS</sub>=1.3A, V<sub>DD</sub>=50V, R<sub>G</sub>=25  $\Omega$ , Starting T<sub>J</sub> = 25°C.

4.  $I_{SD} \le 1.0A$ , di/dt $\le 200A/\mu s$ ,  $V_{DD} \le BV_{DSS}$ , Starting  $T_J = 25^{\circ}C$ .

### THERMAL CHARACTERISTICS

PARAMETER		SYMBOL	RATINGS	UNIT	
Junction to Ambient	SOT-223	0	150	°C/W	
	TO-251	θ <sub>JA</sub>	110	°C/W	
Junction to Case	SOT-223	0	12.5	°C/W	
	TO-251	θ <sub>JC</sub>	4.46	°C/W	



<b>ELECTRICAL CHARACTERISTICS</b> (T <sub>J</sub> =25°C, unless otherwise specified)

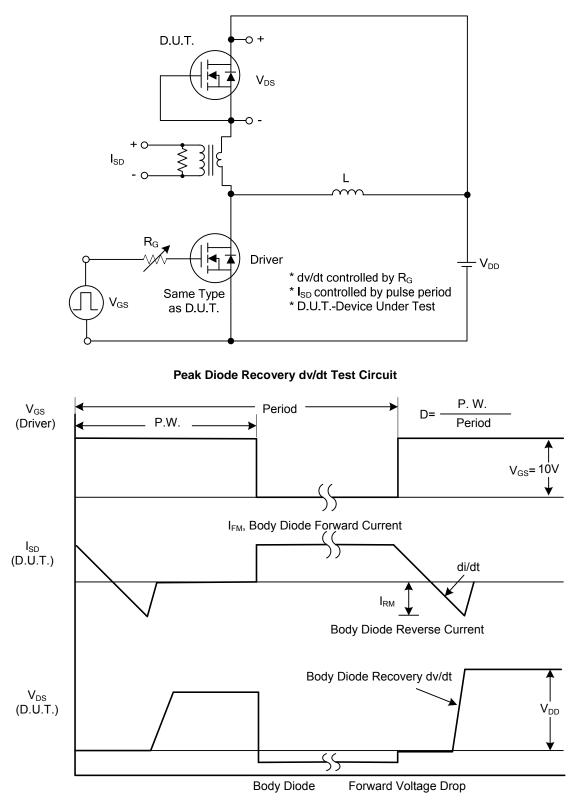
PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
OFF CHARACTERISTICS								
Drain-Source Breakdown Voltage		BV <sub>DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> = 250µA	650			V	
Drain-Source Leakage Current		I <sub>DSS</sub>	$V_{DS} = 650V, V_{GS} = 0V$			10	μA	
Gate-Source Leakage Current	Forward	I <sub>GSS</sub>	V <sub>GS</sub> = 30V, V <sub>DS</sub> = 0V			100	nA	
	Reverse		$V_{GS}$ = -30V, $V_{DS}$ = 0V			-100	nA	
ON CHARACTERISTICS								
Gate Threshold Voltage		V <sub>GS(TH)</sub>	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$ 2			4.5	V	
Static Drain-Source On-State Resistance		R <sub>DS(ON)</sub>	V <sub>GS</sub> = 10V, I <sub>D</sub> =0.5A			4.6	Ω	
DYNAMIC CHARACTERISTICS								
Input Capacitance		C <sub>ISS</sub>			89		рF	
Output Capacitance		Coss	V <sub>GS</sub> =0V, V <sub>DS</sub> =25V, f =1MHz		51		рF	
Reverse Transfer Capacitance		C <sub>RSS</sub>			5.5		рF	
SWITCHING CHARACTERISTICS								
Total Gate Charge (Note 1)		$Q_{G}$	V <sub>DS</sub> =50V, V <sub>GS</sub> =10V, I <sub>D</sub> =1.3A I <sub>G</sub> =100μA (Note 1, 2)		13		nC	
Gate-Source Charge		$Q_{GS}$			2		nC	
Gate-Drain Charge		$Q_{GD}$	$IG = 100 \mu A (100 e^{-1}, 2)$		3.5		nC	
Turn-On Delay Time (Note 1)		t <sub>D (ON)</sub>			28		ns	
Turn-On Rise Time		t <sub>R</sub>	$V_{DD}$ =30V, $V_{GS}$ =10V, $I_{D}$ =0.5A,		30		ns	
Turn-Off Delay Time		t <sub>D(OFF)</sub>	R <sub>G</sub> =25Ω (Note 1, 2)		54		ns	
Turn-Off Fall Time		t <sub>F</sub>			36		ns	
DRAIN-SOURCE DIODE CHARACTERISTICS								
Continuous Drain-Source Current		ls				1.0	Α	
Maximum Body-Diode Pulsed Current		I <sub>SM</sub>				4.0	Α	
Drain-Source Diode Forward Voltage (Note 1)		V <sub>SD</sub>	I <sub>S</sub> =1.0A, V <sub>GS</sub> =0V			1.4	V	
Body Diode Reverse Recovery Time (Note 1)		trr	I <sub>S</sub> =1.0A, V <sub>GS</sub> =0V,		160		nS	
Body Diode Reverse Recovery Charge		Qrr	dl/dt=100A/µs		530		nC	

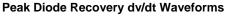
Notes: 1. Pulse Test: Pulse width  $\leq$  300µs, Duty cycle $\leq$ 2%.

2. Essentially independent of operating temperature.



## TEST CIRCUITS AND WAVEFORMS

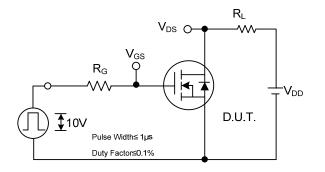


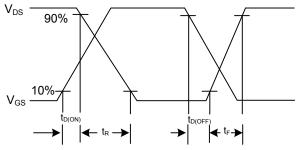




# 1NM65-Q

## ■ TEST CIRCUITS AND WAVEFORMS (Cont.)





Switching Test Circuit



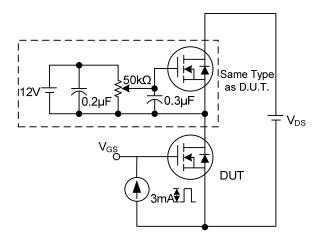
 $\mathsf{Q}_\mathsf{G}$ 

 $\mathsf{Q}_{\mathsf{GD}}$ 

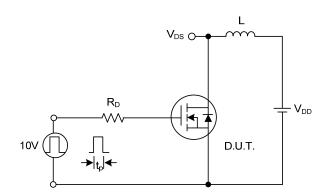
 $\mathsf{V}_{\mathsf{GS}}$ 

10V

Q<sub>GS</sub>



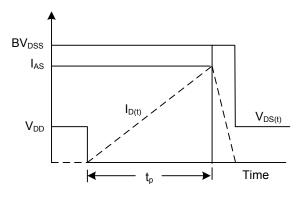
Gate Charge Test Circuit



**Unclamped Inductive Switching Test Circuit** 

Gate Charge Waveform

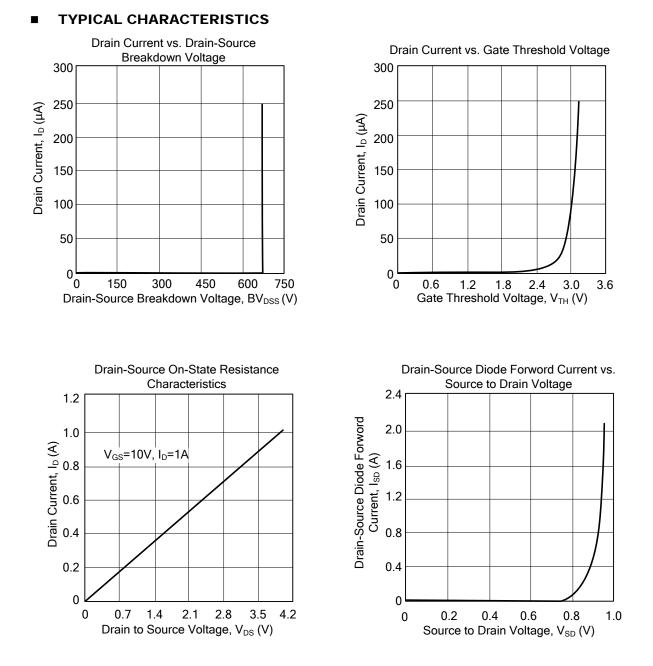
Charge



**Unclamped Inductive Switching Waveforms** 



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